

Wiring, Printed Certified for Canada - Component

COMPANY


Toptek PCB Co Ltd
A417, Building 1, Hedong Industrial Zone
Xin'an Street
Bao'an 49 District
Shenzhen, Guangdong 518101 China

E521933

| Cond Width | | Max Report | | | | Max | | | | | | | | | |
|-----------------------------------|-------|------------|------------|-----|------|------------|------------|----------|---------|--------|--------|-------|---------|-----|---|
| Type | Min | | Cond | SS/ | Area | date | Surface | Assembly | | Solder | Solder | Oper | Meets C | | |
| | Min | Edge | Thk | DS/ | Diam | After | Mount | Process | Process | Limits | Temp | Flame | UL796 | T | |
| | mm | mm | mic | DSO | mm | 2022-01-01 | Technology | Temp °C | Cycles | °C | sec | °C | Class | DSR | I |
| Multilayer printed wiring boards | | | | | | | | | | | | | | | |
| TTP-8 (ASP 1) | 0.075 | 0.075 | 12 Int:102 | DS | 76.2 | Yes | Yes | 260 | 4 | 288 | 20 | 130 | V-0 | All | * |
| Singlelayer Printed Wiring Boards | | | | | | | | | | | | | | | |
| TTP-6 (ASP 1) | 0.075 | 0.075 | 12 | DS | 76.2 | Yes | Yes | 260 | 4 | 288 | 20 | 130 | V-0 | All | * |

* - CTI marking is optional and may be marked on the printed wiring board.

(ASP 1) - Assembly Solder process evaluated to IPC-TM-650, 2.6.27 Thermal Stress Assembly Simulation.

Marking: Company name or file number and type designation and the Recognized Component Mark for Canada, . May be followed by a suffix to denote factory identification or flammability classification..

Last Updated on 2025-03-25

The appearance of a company's name or product in this database does not in itself assure that products so identified have been manufactured under UL Solutions' Follow - Up Service. Only those products bearing the UL Mark should be considered to be Certified and covered under UL Solutions' Follow - Up Service. Always look for the Mark on the product.

UL Solutions permits the reproduction of the material contained in Product iQ subject to the following conditions: 1. The Guide Information, Assemblies, Constructions, Designs, Systems, and/or Certifications (files) must be presented in their entirety and in a non-misleading manner, without any manipulation of the data (or drawings). 2. The statement "Reprinted from Product iQ with permission from UL Solutions" must appear adjacent to the extracted material. In addition, the reprinted material must include a copyright notice in the following format: "©2025 UL LLC."